

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE

**Field Device Integration (FDI) –  
Part 101-1: Profiles – Foundation Fieldbus H1**

**Intégration des appareils de terrain (FDI) –  
Partie 101-1: Profils – Foundation Fieldbus H1**



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IEC Central Office  
3, rue de Varembe  
CH-1211 Geneva 20  
Switzerland

Tel.: +41 22 919 02 11  
Fax: +41 22 919 03 00  
[info@iec.ch](mailto:info@iec.ch)  
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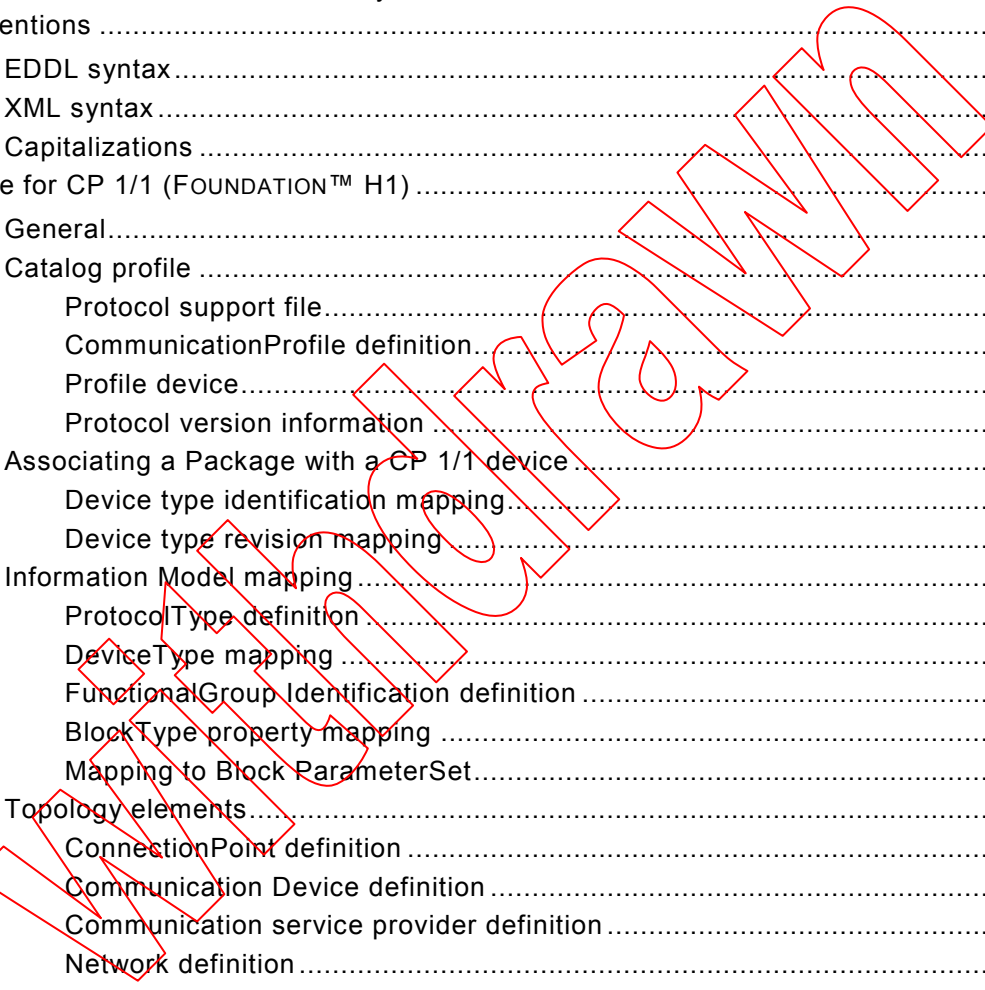
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**FIELD DEVICE INTEGRATION (FDI) –**

**Part 101-1: Profiles – Foundation Fieldbus H1**

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The text of this standard is based on the following documents:

CDV	Report on voting
65E/352/CDV	65E/415/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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